## 3-Pin Switch-Mode LED Lamp Driver

## Features

Constant output current: 100 mAUniversal 85-264VAC operationFixed off-time buck converterInternal 475 V power MOSFET

## Applications

Decorative lightingLow power lighting fixtures

## General Description

The FC9920 is a pulse width modulated (PWM) high efficiency LED driver control IC. It allows efficient operation of LED strings from voltage sources ranging up to 400 VDC . The FC9920 includes an internal high voltage switching MOSFET controlled with fixed off-time ( $\mathrm{T}_{\mathrm{OFF}}$ ) of approximately 10.5 us. The LED string is driven at constant current, thus providing constant light output and enhanced reliability. The output current is internally fixed at 100 mA for FC9920. The peak current control scheme provides good regulation of the output current throughout the universal AC line voltage range of 85 to 264 VAC or DC input voltage of 20 to 400 V and is inherently protected from input under-voltage condition.

## Typical Application Circuit



## Absolute Maximum Ratings

## Pin Configurations

| Parameter | Value |
| :--- | :--- |
| Supply voltage, $\mathrm{V}_{\mathrm{DD}}$ | -0.3 to +10 V |
| Supply current, $\mathrm{IDD}_{\mathrm{DD}}$ | +5 mA |
| Operating ambient temperature range | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Operating junction temperature range | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Storage temperature range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Power dissipation @ $25^{\circ} \mathrm{C}$, SOT -89 | 1600 mW (Mounted on |
|  | FR 4 board, 25 mm x <br> $25 \mathrm{~mm} \times 1.57 \mathrm{~mm})$ |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
Note 1: Also limited by package power dissipation limit, whichever is lower.

## Electrical Characteristics

(Specifications are at $T_{A}=25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\text {DRAIN }}=50 \mathrm{~V}$, unless otherwise noted)

| Symbol | Description | Min. | Typ. | Max. | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Regulator ( $\mathrm{V}_{\mathrm{DD}}$ ) |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\text {DD }}$ regulator output | - | 7.8 | - | V | --- |
| $\mathrm{V}_{\text {DRAIN }}$ | $\mathrm{V}_{\text {DRAIN }}$ supply voltage | 20 | - | - | V | --- |
| $\mathrm{V}_{\text {UVLO }}$ | $\mathrm{V}_{\mathrm{DD}}$ undervoltage threshold | 5.0 | - | - | V | --- |
| $\Delta \mathrm{V}_{\text {UVLO }}$ | $\mathrm{V}_{\mathrm{DD}}$ undervoltage lockout hysteresis | - | 200 | - | mV | --- |
| $\mathrm{I}_{\mathrm{DD}}$ | Operating supply current | - | 220 | 400 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {DD(EXT) }}=8.5 \mathrm{~V}, \mathrm{~V}_{\text {DRAIN }}=40 \mathrm{~V}$ |

## Output (DRAIN)

| $\mathrm{V}_{\text {BR }}$ | Breakdown voltage * | 475 | - | - | V | --- |
| :---: | :--- | :---: | :---: | :---: | :---: | :--- |
| $\mathrm{R}_{\text {ON }}$ | On-resistance | - | - | 100 | $\Omega$ | $\mathrm{I}_{\text {DRAIN }}=100 \mathrm{~mA}$ |
| $\mathrm{C}_{\text {DRAIN }}$ | Output capacitance \# | - | 1.0 | 5.0 | pF | $\mathrm{V}_{\text {DRAIN }}=400 \mathrm{~V}$ |
| $\mathrm{I}_{\text {SAT }}$ | MOSFET saturation current \# | 150 | 210 | - | mA | --- |

Current Sense Comparator

| $\mathrm{I}_{\mathrm{TH}}$ | Threshold average current * | 98 | 115 | 126 | mA | --- |
| :---: | :--- | :---: | :---: | :---: | :---: | :--- |
| $\mathrm{T}_{\text {BLANK }}$ | Leading edge blanking delay * \# | 200 | 300 | 400 | ns | --- |
| $\mathrm{T}_{\text {ON(MIN })}$ | Minimum on-time | - | - | 1300 | ns | --- |

## OFF-Time Generator

| $\mathrm{T}_{\text {OFF }}$ |  | 8 | 10.5 | 13 | $\mu \mathrm{~s}$ | --- |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

## Note:

*- Denotes the specifications which apply over the full operating ambient temperature range of $-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<+85^{\circ} \mathrm{C}$.
\# - Denotes guaranteed by design.

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## Functional Description

## Input Voltage Regulator

The FC9920 is a PWM peak current controller for controlling a buck converter topology in continuous conduction mode (CCM). The output current is internally preset at 100 mA .
When the input voltage of 20 to 400 V appears at the DRAIN pin, the internal high-voltage linear regulator seeks to maintain a constant voltage 7.8 VDC at the $V_{D D}$ pin. Until this voltage exceeds the internally programmed under-voltage threshold, the output switching MOSFET is non-conductive. When the threshold is exceeded, the MOSFET turns on. The input current begins to flow into the DRAIN pin. Hysteresis is provided in the under-voltage comparator to prevent oscillation.
When the input current exceeds the internal preset level, a current sense comparator resets an RS flipflop, and the MOSFET turns off. At the same time, a one-shot circuit is activated that determines the duration of the off-state ( $10.5 \mu \mathrm{~s}$ typ.). As soon as this time is over, the flip-flop sets again. The new switching cycle begins.
A "blanking" delay of 300 ns is provided that prevent false triggering of the current sense comparator due to the leading edge spike caused by circuit parasitics.

## Application Information

The FC9920 is a low-cost off-line buck converter IC specifically designed for driving multi-LED strings. It can be operated from either universal AC line range of 85 to 264 VAC , or 20 to 400 VDC , and drives up to tens of high brightness LEDs. All LEDs can be run in series, and the FC9920 regulates at constant current, yielding uniform illumination. The FC9920 is compatible with triac dimmers. The output current is internally fixed at 100 mA . This part is available in space saving TO-92 and SOT-89 package.

## Selecting L1 and D1

There is a certain trade-off to be considered between optimal sizing of the output inductor L1 and the tolerated output current ripple. The required value of L 1 is inversely proportional to the ripple current $\Delta \mathrm{I}_{\mathrm{O}}$ in it.

$$
\begin{equation*}
\mathbf{L} 1=\left(\mathbf{V}_{\mathbf{O}} \cdot \mathrm{T}_{\mathbf{O F F}}\right) /\left.\Delta\right|_{\mathbf{O}} \tag{1}
\end{equation*}
$$

where $\mathrm{V}_{\mathrm{O}}$ is the forward voltage of the LED string. $\mathrm{T}_{\text {OFF }}$ is the off-time of the FC9920.The output current in the LED string $\left(\mathrm{I}_{\mathrm{O}}\right)$ is calculated then as:
$\mathbf{I}_{\mathbf{O}}=\mathbf{I}_{\mathrm{TH}}-\left(\Delta \mathrm{l}_{\mathbf{O}} / 2\right)$
(2)
where $\mathrm{I}_{\mathrm{TH}}$ is the current sense comparator threshold. The ripple current introduces a peak-to-average error in the output current setting that needs to be accounted for. Due to the constant off-time control technique used in the FC9920, the ripple current is independent of the input AC or DC line voltage variation. Therefore, the output current will remain unaffected by the varying input voltage.
Adding a filter capacitor across the LED string can reduce the output current ripple even further, thus permitting a reduce value of L1. However, one must keep in mind that the peak-to-average current error is affected by the variation of $\mathrm{T}_{\text {off }}$. Therefore, the initial output current accuracy might be sacrificed at large ripple current in L1.
Another important aspect of designing an LED driver with the FC9920 is related to certain parasitic elements of the circuit, including distributed coil capacitance of L1, junction capacitance and reverse recovery of the rectifier diode D1, capacitance of the printed circuit board traces $\mathrm{C}_{\text {PCB }}$ and output capacitance $C_{\text {DRAIN }}$ of the controller itself. These parasitic elements affect the efficiency of the switching converter and could potentially cause false triggering of the current sense comparator if not properly managed. Minimizing these parasitics is essential for efficient and reliable operation of the FC9920.

Coil capacitance of inductors is typically provided in the manufactures data books either directly or in terms of the self-resonant frequency (SRF).
SRF $=1 /\left[2 \pi \cdot \sqrt{ }\left(L_{i} C\right)\right]$
where $L$ is the inductance value, and $C_{L}$ is the coil capacitance. Charging and discharging this capacitance every switching cycle causes highcurrent spikes in the LED string. Therefore, connecting a small capacitor $\mathrm{C}_{\mathrm{O}}(\sim 10 \mathrm{nF})$ is recommended to bypass these spikes.
Using an ultra-fast rectifier diode for D1 is recommended to achieve high efficiency and reduce the risk of false triggering of the current sense comparator. Using diodes with shorter reverse recovery time $\mathrm{t}_{\mathrm{rr}}$ and lower junction capacitance $\mathrm{C}_{\mathrm{J}}$ achieves better performance. The reverse voltage rating $V_{R}$ of the diode must be greater than the maximum input voltage of the LED lamp.
The total parasitic capacitance present at the DRAIN pin of the An9920 can be calculated as:
$\mathrm{C}_{\mathrm{P}}=\mathrm{C}_{\text {DRAIN }}+\mathrm{C}_{\text {PCB }}+\mathrm{C}_{\mathrm{L}}+\mathrm{C}_{\mathrm{J}}$

When the switching MOSFET turns on, the capacitance $C_{p}$ is discharged into the DRAIN pin of the IC. The discharge current is limited to about 210 mA typically. However, it may become lower at increased junction temperature. The duration of the leading edge current spike can be estimated as:

$$
\begin{equation*}
\mathbf{T}_{\mathrm{SPIKE}}=\left[\left(\mathbf{V}_{\mathrm{IN}} \cdot \mathrm{C}_{\mathrm{P}}\right) /\left(\mathbf{I}_{\mathrm{SAT}}\right)\right]+\mathrm{t}_{\mathrm{rI}} \tag{4}
\end{equation*}
$$

In order to avoid false triggering of the current sense comparator, $\mathrm{C}_{\mathrm{P}}$ must be minimized in accordance with the following expression:
$\mathbf{C}_{\mathbf{P}}<\mathbf{I}_{\text {SAT }} \cdot\left(\mathbf{T}_{\text {BLANK(MIN) }}-\mathrm{t}_{\mathrm{rr}}\right) / \mathbf{V}_{\text {IN(MAX) }}$
where $\mathrm{T}_{\text {BLANK(MIN) }}$ is the minimum blanking time of 200ns, and $\mathrm{V}_{\text {IN(MAX) }}$ is the maximum instantaneous input voltage.

## Estimating Power Loss

Discharging the parasitic capacitance CP into the DRAIN pin of the FC9920 is responsible for the bulk of the switching power loss. It can be estimated using the following equation:
$\mathbf{P}_{\text {SWITCH }}=\left[\left(\mathbf{V}_{\text {IN }}{ }^{2} \cdot C_{\mathbf{P}} / \mathbf{2}\right)+\left.\mathbf{V}_{\text {IV }} \cdot\right|_{\text {SAT }} \cdot \mathrm{t}_{\mathrm{rr}}\right] \cdot \mathbf{F}_{\text {S }}(\mathbf{6})$ where $F_{s}$ is the switching frequency, $I_{\text {SAT }}$ is the saturated DRAIN current of the FC9920. The switching loss is the greatest at the maximum input voltage. The switching frequency is given by the following:
$\mathbf{F}_{\mathrm{S}}=\left(\mathbf{V}_{\mathrm{IN}}-\eta^{-1} \cdot \mathrm{~V}_{\mathrm{O}}\right) / \mathbf{V}_{\mathrm{IN}} \cdot \mathrm{T}_{\mathbf{O F F}}$
where $\eta$ is the efficiency of the power converter.
When the FC9920 LED driver is powered from the full-wave rectified AC input, the switching power loss can be estimated as:
$\mathbf{P}_{\text {SWIYCH }} \approx\left[1 /\left(2 \cdot \mathrm{G}_{\mathrm{GF}}\right)\right] \cdot\left(V_{\mathrm{AC}} \cdot \mathbf{P}+\left.2 \cdot\right|_{\mathrm{SAT}} \cdot \mathrm{t}_{\mathrm{IT}}\right)$.
$\left(V_{A C}-\eta^{-1} \cdot V_{0}\right)$
$\mathrm{V}_{\mathrm{AC}}$ is the input AC line voltage.
The switching power loss associated with turn-off transitions of the DRAIN pin can be disregarded. Due to the large amount of parasitic capacitance connected to this switching node, the turn-off transition occurs essentially at zero- voltage. Conduction power loss in the FC9920 can be calculated as:
$\mathbf{P}_{\text {COND }}=\left(D \cdot I_{\mathbf{O}}^{2} \cdot R_{\text {ON }}\right)+\left[\mathbf{I}_{\text {DD }} \cdot V_{\text {IN }} \cdot(1-\mathbf{D})\right]$
where $\mathbf{D}=\mathbf{V}_{\mathbf{O}} /\left(\eta \cdot V_{\mathbf{I N}}\right)$ is the duty ratio, $\mathrm{R}_{\mathrm{ON}}$ is the on-resistance, IDD is the internal linear regulator current.

When the LED driver is powered from the fullwave rectified AC line input, the exact equation for calculating the conduction loss is more cumbersome. However, it can be estimated using the following equation:
$\mathbf{P}_{\text {COND }}=\left(\left.K_{C} \cdot\right|_{\mathbf{O}}{ }^{2} \cdot R_{\text {ON }}\right)+\left(\left.K_{D} \cdot\right|_{D D} \cdot V_{A C}\right)$
where $V_{A C}$ is the input $A C$ line voltage. The coefficients $K_{C}$ and $K_{D}$ can be determined from the minimum duty ratio of the FC9920.


Fig.1. Conduction Loss Coefficients $K_{C}$ and $K_{D}$

## EMI Filter

As with all off-line converters, selecting an input filter is critical to obtaining good EMI. A switching side capacitor, albeit of small value, is necessary in order to ensure low impedance to the high frequency switching current of the converter. As a rule of thumb, this capacitor should be approximately $0.1-0.2 \mu \mathrm{~F} / \mathrm{W}$ of LED output power. A recommended input filter is shown in Figure 2 for the following design example.

## Design Example

Let us design an FC9920 LED lamp driver meeting the following specification:
Input: Universal AC, 85-135VAC
Output Current: 100mA
Load: String of 24 LED (Power TOPLED
OSRAM $^{\circledR} \mathrm{V}_{\mathrm{F}}=2.5 \mathrm{~V}$ max. each)
Step 1. Calculation L1.
The output voltage $\mathrm{V}_{\mathrm{O}}=24 \mathrm{x} \mathrm{V}_{\mathrm{F}}=60 \mathrm{~V}$ (max.). Use equation (1) assuming a $30 \%$ peak-to-peak ripple.

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$\mathrm{L} 1=(60 \mathrm{~V} \cdot 10.5 \mu \mathrm{~s}) /(0.3 \cdot 100 \mathrm{~mA})=21 \mathrm{mH}$ Select L1 = 22mH, I = 150mA. Typical SRF = 270 KHz . Calculate the coil capacitance.
$\mathrm{C}_{\mathrm{L}}=1 /\left[\mathrm{L} 1 \cdot(2 \pi \cdot \mathrm{SRF})^{2}\right]=1 /[22 \mathrm{mH} \cdot(2 \pi \cdot$
$\left.270 \mathrm{KHz})^{2}\right] \approx 15 \mathrm{pF}$
Step 2. Selecting D1.
Select D1 MUR160 with $V_{R}=600 \mathrm{~V}$, trr $\approx 50 \mathrm{~ns}$ and $C_{\mathrm{J}} \approx 8 \mathrm{pF}\left(\mathrm{V}_{\mathrm{R}}>50 \mathrm{~V}\right)$.
Step 3. Calculating total parasitic capacitance using (3).
$\mathrm{C}_{\mathrm{P}}=5 \mathrm{pF}+5 \mathrm{pF}+15 \mathrm{pF}+8 \mathrm{pF}=33 \mathrm{pF}$
Step 4. Calculating the leading edge spike duration using (4), (5).
$\mathrm{T}_{\text {SPIKE }}=(135 \mathrm{~V} \cdot \sqrt{ } 2 \cdot 33 \mathrm{pF}) / 150 \mathrm{~mA}+50 \mathrm{~ns} \approx$
$92 \mathrm{~ns}<\mathrm{T}_{\text {BLANK(MIN) }}=200 \mathrm{~ns}$
Step 5. Estimating power dissipation in An9920 at 135VAC using (8) and (10).

Let us assume that the overall efficiency $\eta=0.7$.
Switching Power Loss
$\mathrm{P}_{\text {SWITCH }}=(135 \mathrm{~V} \cdot 33 \mathrm{pF}+2 \cdot 150 \mathrm{~mA} \cdot 50 \mathrm{~ns})$.
$(135 \mathrm{~V}-60 \mathrm{~V} / 0.7) /(2 \cdot 10.5 \mu \mathrm{~s}) \approx 46 \mathrm{~mW}$
Minimum Duty Ratio
$\mathrm{D}_{\mathrm{M}}=60 \mathrm{~V} /(0.7 \cdot 135 \mathrm{~V} \cdot \sqrt{ } 2) \approx 0.45$
Conduction Power Loss
$P_{\text {COND }}=0.42 \cdot(100 \mathrm{~mA})^{2} \cdot 100 \Omega+0.570 \cdot 20 \mu \mathrm{~A}$.
$135 \mathrm{~V} \approx 435 \mathrm{~mW}$
Total Power Dissipation in An9920:
$\mathrm{P}_{\text {TOTAL }}=46 \mathrm{~mW}+435 \mathrm{~mW}=481 \mathrm{~mW}$
Step 6. Selecting input capacitor $\mathrm{C}_{\mathrm{IN}}$
Output Power $=60 \mathrm{~V} \cdot 100 \mathrm{~mA}=6 \mathrm{~W}$
Select $\mathrm{C}_{\mathrm{IN}}=0.68 \mu \mathrm{~F}, 250 \mathrm{~V}$

Figure 2. Universal 85-135VAC LED Lamp Driver


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Figure 3. Typical Efficiency Efficiency (\%)


Figure 5. Lead Edge Spike Ch1: V ${ }_{\text {DRain }}$, Ch3: I Imain


Functional Block Diagram


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## FC9920 Layout Considerations

See Figure 7 for a recommended circuit board layout for the FC9920.

## Single Point Grounding

Use a single point ground connection from the input filter capacitor to the area of copper connected to the GND pin.

## Bypass Capacitor ( $\mathbf{C D D}_{\mathrm{DD}}$ )

The $V_{D D}$ pin bypass capacitor $C_{D D}$ should be located as near as possible to the $V_{D D}$ and GND pins.

## Switching Loop Areas

The area of the switching loop connecting the input filter capacitor $\mathrm{C}_{\text {IN }}$, the diode D1 and the FC9920 together should be kept as small as possible.
The switching loop area connecting the output filter capacitor $\mathrm{C}_{\mathrm{O}}$, the inductor L 1 and the diode D1 together should be kept as small as possible.

## Thermal Considerations vs. Radiated EMI

The cooper area where GND pin is connected acts not only as a single point ground, but also as a heat sink.
This area should be maximized for good heat sinking, especially when FC9920 (SOT-89 package), is used.
The same applies to the cathode of the free-wheeling diode D1. Both nodes are quiet and therefore, will not cause radiated RF emission. The switching node copper area connected to the DRAIN pin of the FC9920, the anode of D1 and the inductor L1 needs to be minimized. A large switching node area can increase high frequency radiated EMI.

## Input Filter Layout Considerations

The input circuit of the EMI filter must not be placed in the direct proximity to the inductor L1 in order to avoid magnetic coupling of its leakage fields. This consideration is especially important when unshielded construction of L1 is used. When an axial input EMI filter inductor $\mathrm{L}_{\text {IN }}$ is selected, it must be positioned orthogonal with respect to L 1 . The loop area formed by $\mathrm{C}_{\mathrm{IN} 2}, \mathrm{~L}_{\mathrm{IN}}$, and $\mathrm{C}_{\mathrm{IN}}$ should be minimized. The input lead wires must be twisted together.

Figure7. Recommended circuit board layout with the FC9920 (SOT-89 package)


